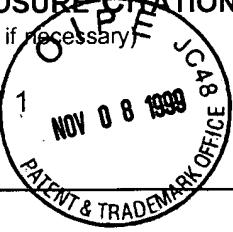


FORM HDP-1449 (Based on Form PTO-1449)		ATTORNEY DOCKET NO. 9319S-000062	SERIAL NO. 09/068,270
PATENT AND TRADEMARK OFFICE INFORMATION DISCLOSURE CITATION (Use several sheets if necessary)		APPLICANT Kenji UCHIYAMA	
Sheet 1 of 1		FILING DATE May 4, 1998	GROUP 2822
			

U.S. PATENT DOCUMENTS

Ref. Desig.	Examiner's Initials	Document Number	Date	Name	Class/ Subclass	(If appropriate) Filing Date
1.	JMM	4,604,644	08/1986	Beckham et al		
2.		5,187,123	02/1993	Yoshida et al		
3.		5,232,962	08/1993	Dershem et al		

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Ref. Desig.	Examiner's Initials	Document Number	Date	Country	Class/ Subclass	Translation	
Ref. Desig.	Examiner's Initials	Document Number	Date	Country	Class/ Subclass	Yes	No
1.	JMM	0 265 077	1988	European Patent Office			
2.		0 517 071 A1	1992	European Patent Office			

OTHER DOCUMENTS (including Author, Title, Date, Pertinent Pages, etc.)

Ref. Desig.	Examiner's Initials	
1.	JMM	Gilleo, K., "Direct Chip Interconnect Using Polymer Bonding", IEEE Transactions on Components, Hybrids and Manufacturing Technology, Vol 13, No. 1, 1 March 1990, pps 229-234.
2.		Jin, Sungho et al, "Anisotropically Conductive Polymer Films with a Uniform Dispersion of Particles", IEEE Transactions on Components, Hybrids and Manufacturing Technology, Vol. 16, No. 8, 1 December 1993, pps 972-977.

Examiner:

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